



# PAM2306D

## DUAL HIGH-EFFICIENCY PWM STEP-DOWN DC-DC CONVERTER

## Description

The PAM2306D is a dual step-down current mode, DC-DC converter. At heavy load, the constant-frequency PWM control performs excellent stability and transient response. To ensure the longest battery life in portable applications, the PAM2306D provides a powersaving Pulse-Skipping Modulation (PSM) mode to reduce quiescent cur rent under light load operation.

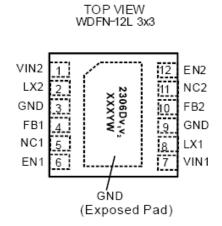
The PAM2306D supports a range of input voltages from 2.5V to 5.5V, allowing the use of a single Li+/Li-polymer cell, multiple Alkaline/NiMH cell, USB, and other standard power sources. The dual output voltages are available for adjustment. All versions employ internal power switch and synchronous rectifier to minimize external part count and realize high efficiency. During shutdown, the input is disconnected from the output and the shutdown current is less than 0.1 $\mu$ A. Other key features include under-voltage lockout to prevent deep battery discharge.

## **Features**

- Efficiency up to 96%
- Only 40µA (Typ per Channel) Quiescent Current
- Output Current: Up to 1A per Channel
- Internal Synchronous Rectifier
- 1.5MHz Switching Frequency
- Soft-Start
- Under-Voltage Lockout
- Short Circuit Protection
- Thermal Shutdown
- Small 12L WDFN3x3 Package
- Pb-Free and RoHS Compliant

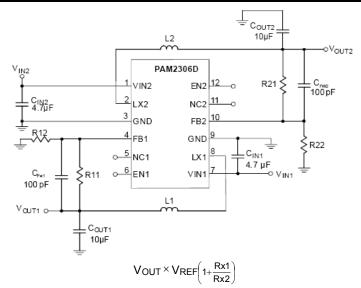
# **Typical Applications Circuit**





# Applications

- Cellular Phone
- Portable Electronics
- Personal Information Appliances
- Wireless and DSL Modems
- MP3 Players



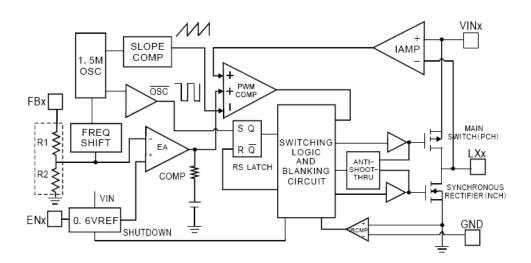




# **Pin Descriptions**

Pin Number	Pin Name WDFN3x3-12L	Function
1	VIN2	Power Input of Channel 2.
2	LX2	Pin for Switching of Channel 2.
3, 9 Exposed Pad	GND	Ground. The exposed pad must be soldered to a large PCB and connected to GND for maximum power dissipation.
4	FB1	Feedback of Channel 1.
5, 11	NC1, NC2	No Connection
6	EN1	Chip Enable of Channel 1 (Active High). V <sub>EN1</sub> ≤ V <sub>IN1</sub> .
7	VIN1	Power Input of Channel 1.
8	LX1	Pin for Switching of Channel 1.
10	FB2	Feedback of Channel 2.
12	EN2	Chip Enable of Channel 2 (Active High). $V_{EN2} \leq V_{IN2}$ .

# **Functional Block Diagram**







# PAM2306D

## Absolute Maximum Ratings (@TA = +25°C, unless otherwise specified.)

These are stress ratings only and functional operation is not implied. Exposure to absolute maximum ratings for prolonged time periods may affect device reliability. All voltages are with respect to ground.

Parameter	Rating	Unit
Input Voltage	-0.3 to +6.5	V
EN1, FB1, LX1, EN2, FB2 and LX2 Pin Voltage	-0.3 to (V <sub>IN</sub> +0.3)	V
Maximum Junction Temperature	150	°C
Storage Temperature Range	-65 to +150	°C
Soldering Temperature	260, 10sec	°C

## Recommended Operating Conditions (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Parameter	Rating	Unit
Supply Voltage	2.5 to 5.5	V
Ambient Temperature Range	-40 to +85	°C
Junction Temperature Range	-40 to +125	°C

# **Thermal Information**

Parameter	Symbol	Package	Maximum	Unit
Thermal Resistance (Junction to Ambient)	$\theta_{JA}$	W-DFN3x3-12	60	°C/W
Thermal Resistance (Junction to Case)	θ <sub>JC</sub>	W-DFN3x3-12	8.5	°C/W
Power Dissipation	PD	W-DFN3x3-12	1.66	W

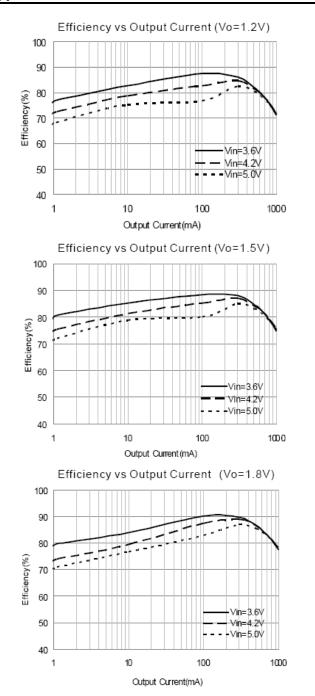
## **Electrical Characteristics**

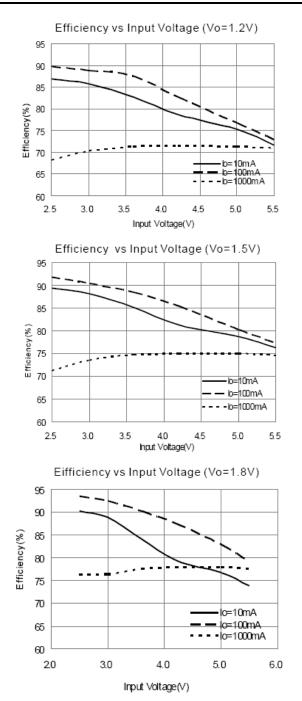
(@T<sub>A</sub> = +25°C, V<sub>IN</sub> = 3.6V, V<sub>O</sub> = 1.8V, C<sub>IN</sub> = 10 $\mu$ F, C<sub>O</sub> = 10 $\mu$ F, L = 2.2 $\mu$ H, unless otherwise specified.)

Parameter	Symbol	Test	Conditions	Min	Тур	Max	Units
Input Voltage Range	V <sub>IN</sub>			2.5		5.5	V
Regulated Feedback Voltage	V <sub>FB</sub>	lo = 100mA		0.588	0.6	0.612	V
Reference Voltage Line Regulation	$\Delta V_{FB}$				0.3		%/V
Regulated Output Voltage Accuracy	Vo	I <sub>O</sub> = 10mA		-3		+3	%
Peak Indictor Current	I <sub>PK</sub>	V <sub>IN</sub> = 3V, V <sub>FB</sub> = 0	.5V or V <sub>O</sub> = 90%		1.5		А
Output Voltage Line Regulation	LNR	V <sub>IN</sub> = 2.5V to 5V,	I <sub>O</sub> = 10mA		0.2	0.5	%/V
Output Voltage Load Regulation	LDR	$I_{O}$ = 1mA to 1A			1.5		%
Quiescent Current (per channel)	l <sub>Q</sub>	No load			40	70	μA
Shutdown Current (per channel)	I <sub>SD</sub>	V <sub>EN</sub> = 0V			0.1	1	μA
	£	V <sub>O</sub> = 100%		1.2	1.5	1.8	MHz
Oscillator Frequency	f <sub>OSC</sub>	$V_{FB}$ = 0V or $V_{O}$ =	0V		500		kHz
Drain-Source On-State Resistance	D	L = 100mA	P MOSFET		0.30	0.45	Ω
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	I <sub>DS</sub> = 100mA	N MOSFET		0.35	0.50	Ω
SW Leakage Current (per channel)	I <sub>LSW</sub>				±0.01	1	μA
EN Threshold High	V <sub>EH</sub>			1.5			V
EN Threshold Low	V <sub>EL</sub>					0.3	V
EN Leakage Current	I <sub>EN</sub>				±0.01		μA
Over Temperature Protection	OTP				150		°C
OTP Hysteresis	OTH				30		°C



## Typical Performance Characteristics (@TA = +25°C, CIN = 10µF, CO = 10µF, L = 4.7µH, unless otherwise specified.)







60

50

40

100

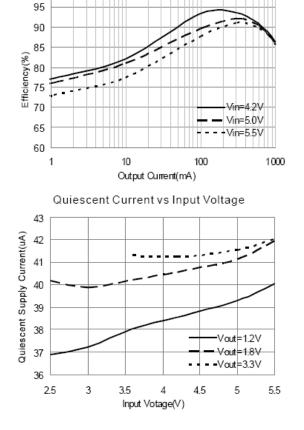
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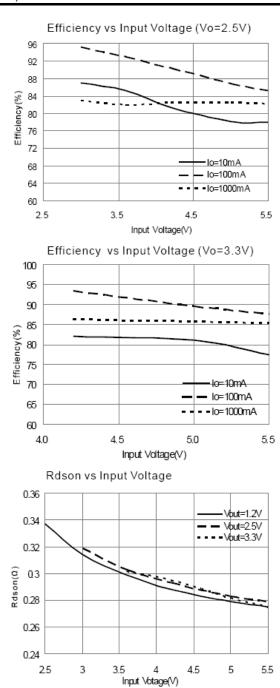
# (@T<sub>A</sub> = +25°C, C<sub>IN</sub> = 10 $\mu$ F, C<sub>O</sub> = 10 $\mu$ F, L = 4.7 $\mu$ H, unless otherwise specified.) Efficiency vs Output Current (Vo=2.5V) 100 90 Efficiency(%) 04 02 08

Output Ourrent(mA)

Efficiency vs Output Current (Vo=3.3V)

10





**Typical Performance Characteristics (cont.)** 

Vin=3.6V

Vin=4.2V

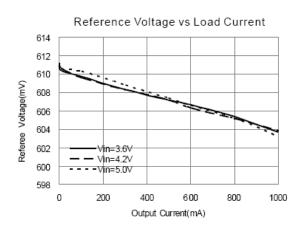
1000

- - - Vin=5.0V

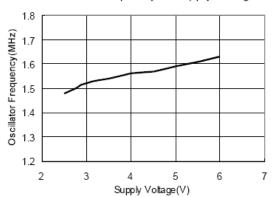
100

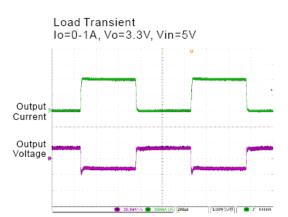


### **Typical Performance Characteristics** (cont.) (@T<sub>A</sub> = +25°C, C<sub>IN</sub> = 10 $\mu$ F, C<sub>O</sub> = 10 $\mu$ F, L = 4.7 $\mu$ H, unless otherwise specified.)



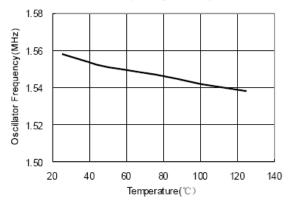
Oscillator Frequency vs Supply Voltage



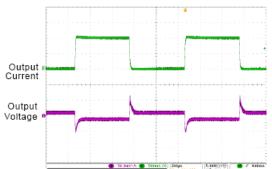


Output Voltage vs Load Current 1.235 1.230 1.225 Output Voltage(V) 1.220 1.215 1.210 Vin=3.6V Vin=4.2V Vin=5.0V 1.205 1.200 0 200 400 600 800 1000 Output Current(mA)

Oscillator Frequency vs Temperature



Load Transient Io=0-1A, Vo=1.2V, Vin=5V





## **Application Information**

The basic PAM2306D application circuit is shown in Page 1. External component selection is determined by the load requirement, selecting L first and then C<sub>IN</sub> and C<sub>OUT</sub>.

#### **Inductor Selection**

For most applications, the value of the inductor will fall in the range of  $1\mu$ H to  $4.7\mu$ H. Its value is chosen based on the desired ripple current. Large value inductors lower ripple current and small value inductors result in higher ripple currents. Higher V<sub>IN</sub> or V<sub>OUT</sub> also increases the ripple current as shown in Equation 1. A reasonable starting point for setting ripple current is  $\Delta I_L = 400$ mA (40% of 1A).

Equation (1)

$$\Delta I_{L} = \frac{1}{(f)(L)} V_{OUT} \left( 1 - \frac{V_{OUT}}{V_{IN}} \right)$$

The DC current rating of the inductor should be at least equal to the maximum load current plus half the ripple current to prevent core saturation. Thus, a 1.4A rated inductor should be enough for most applications (1A + 400mA). For better efficiency, choose a low DC-resistance inductor

	Vo	1.2V	1.5V	1.8V	2.5V	3.3V	
1	L	2.2 µH	2.2 µH	2.2 µH	4.7 µH	4.7µH	

#### CIN and COUT Selection

In continuous mode, the source current of the top MOSFET is a square wave of duty cycle V<sub>OUT</sub>/V<sub>IN</sub>. To prevent large voltage transients, a low ESR input capacitor sized for the maximum RMS current must be used. The maximum RMS capacitor current is given by:

$$C_{\text{IN}} \text{required}_{\text{RMS}} \cong I_{\text{OMAX}} \frac{\left[V_{\text{OUT}} (V_{\text{IN}} - V_{\text{OUT}})\right]^{1/2}}{V_{\text{IN}}}$$

This formula has a maximum at  $V_{IN} = 2V_{OUT}$ , where  $I_{RMS} = I_{OUT}/2$ . This simple worst-case condition is commonly used for design because even significant deviations do not offer much relief. Note that the capacitor manufacturer's ripple current ratings are often based on 2000 hours of life. This makes it advisable to further derate the capacitor, or choose a capacitor rated at a higher temperature than required. Consult the manufacturer if there is any question.

The selection of C<sub>OUT</sub> is driven by the required effective series resistance (ESR).

Typically, once the ESR requirement for  $C_{OUT}$  has been met, the RMS current rating generally far exceeds the I<sub>RIPPLE</sub> (P-P) requirement. The output ripple  $\Delta V_{OUT}$  is determined by:

$$\Delta V_{OUT} \cong \Delta I_{L} \left( \mathsf{ESR} + \frac{1}{8 \mathsf{fC}_{OUT}} \right)$$

Where f = operating frequency,  $C_{OUT}$  = output capacitance and  $\Delta I_L$  = ripple current in the inductor. For a fixed output voltage, the output ripple is highest at maximum input voltage since  $\Delta I_L$  increases with input voltage.

#### **Using Ceramic Input and Output Capacitors**

Higher values, lower cost ceramic capacitors are now becoming available in smaller case sizes. Their high ripple current, high voltage rating and low ESR make them ideal for switching regulator applications. Using ceramic capacitors can achieve very low output ripple and small circuit size.

When choosing the input and output ceramic capacitors, choose the X5R or X7R dielectric formulations. These dielectrics have the best temperature and voltage characteristics of all the ceramics for a given value and size.

#### **Thermal Consideration**

Thermal protection limits power dissipation in the PAM2306D. When the junction temperature exceeds 150°C, the OTP (Over Temperature Protection) starts the thermal shutdown and turns the pass transistor off. The pass transistor resumes operation after the junction temperature drops below 120°C.

For continuous operation, the junction temperature should be maintained below 125°C. The power dissipation is defined as:

$$P_{D} = I_{O}^{2} \frac{V_{O}R_{DS(ON)H} + (V_{IN} - V_{O})R_{DS(ON)L}}{V_{IN}} + (t_{SW}F_{S}I_{O} + I_{Q})V_{IN}$$

1

IQ is the step-down converter quiescent current. The term tsw is used to estimate the full load step-down converter switching losses.

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## Application Information (cont.)

For the condition where the step-down converter is in dropout at 100% duty cycle, the total device dissipation reduces to:

$$P_{\rm D} = I_{\rm O}^2 R_{\rm DS(ON)H} + I_{\rm Q} V_{\rm IN}$$

Since R<sub>DS(ON)</sub>, quiescent current, and switching losses all vary with input voltage, the total losses should be investigated over the complete input voltage range. The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surrounding airflow and temperature difference between junction and ambient. The maximum power dissipation can be calculated by the following formula:

$$P_{D} = \frac{T_{J(MAX)} - T_{A}}{\theta_{JA}}$$

Where  $T_{J(MAX)}$  is the maximum allowable junction temperature 125°C.  $T_A$  is the ambient temperature and  $\theta_{JA}$  is the thermal resistance from the junction to the ambient. Based on the standard JEDEC for a two layers thermal test board, the thermal resistance  $\theta_{JA}$  of WDFN3X3 is 60°C/W. The maximum power dissipation at  $T_A = +25$ °C can be calculated by following formula:

P<sub>D</sub> = (125°C - 25°C)/60°C/W = 1.66W

### Selecting the Output Voltage

The internal reference is 0.6V (Typical). The output voltage is calculated as below:

$$V_0 = 0.6 \times \left(1 + \frac{R1}{R2}\right)$$

The output voltage is given by Table 1.

Table 1: Resistor selection for output voltage setting.

Vo	R1	R2
1.2V	100k	100k
1.5V	150k	100k
1.8V	200k	100k
2.5V	380k	120k
3.3V	540k	120k

#### 100% Duty Cycle Operation

As the input voltage approaches the output voltage, the converter turns the P-Channel transistor continuously on. In this mode the output voltage is equal to the input voltage minus the voltage drop across the P-Channel transistor:

 $V_{OUT} = V_{IN} - I_{LOAD} (R_{DS(ON)} + R_L)$ 

where R<sub>DS(ON)</sub> = P-Channel switch ON resistance, I<sub>LOAD</sub> = Output Current, R<sub>L</sub> = Inductor DC Resistance

#### UVLO and Soft-Start

The reference and the circuit remain reset until the V<sub>IN</sub> crosses its UVLO threshold.

The PAM2306D has an internal soft-start circuit that limits the in-rush current during start-up. This prevents possible voltage drops of the input voltage and eliminates the output voltage overshoot. The soft-start acts as a digital circuit to increase the switch current in several steps to the P-Channel current limit (1500mA).

#### **Short Circuit Protection**

The switch peak current is limited cycle-by-cycle to a typical value of 1500mA. In the event of an output voltage short circuit, the device operates with a frequency of 400kHz and minimum duty cycle, therefore the average input current is typically 200mA.

#### **Thermal Shutdown**

When the die temperature exceeds 150°C, a reset occurs and the reset remains until the temperature decrease to 120°C, at which time the circuit can be restarted.



# PAM2306D

## Application Information (cont.)

#### PCB Layout Check List

When laying out the printed circuit board, the following checklist should be used to ensure proper operation of the PAM2306D. These items are also illustrated graphically in Figure 1. Check the following in your layout:

- 1. The power traces, consisting of the GND trace, the SW trace and the  $V_{IN}$  trace should be kept short, direct and wide.
- 2. Does the FB pin connect directly to the feedback resistors? The resistive divider R1/R2 must be c onnected between the (+) plate of C<sub>OUT</sub> and ground.
- 3. Does the (+) plate of C<sub>IN</sub> connect to V<sub>IN</sub> as closely as possible? This capacitor provides the AC current to the internal power MOSFETs.
- 4. Keep the switching node, SW, away from the sensitive FB node.
- 5. Keep the (–) plates of  $C_{IN}$  and  $C_{OUT}$  as close as possible.

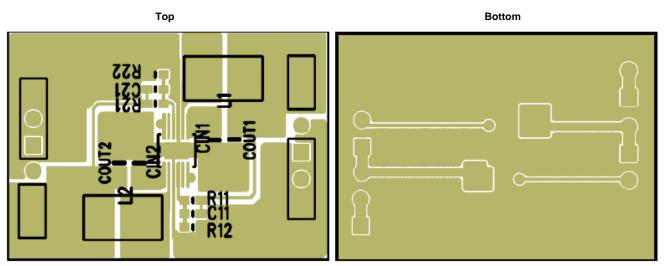
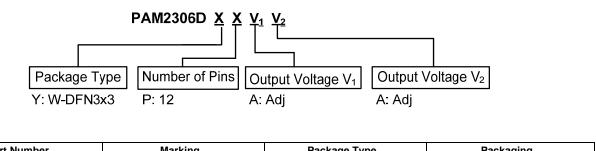


Figure 1. PAM2306D Suggested Layout





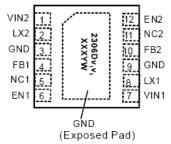
# **Ordering Information**



Part Number	Marking	Package Type	Packaging
PAM2306DYPv1v2	2306Dv <sub>1</sub> v <sub>2</sub> X XXYW	W-DFN3x3-12	3000 Units/ Tape&Reel

# **Marking Information**





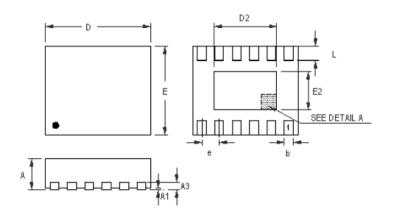
v1: Output Voltage 1

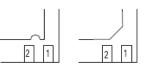
- Output Voltage 2 V 2: (refer to "Ordering
- Information") Internal Code
- X: Y: Year
- W: Week



## Package Outline Dimensions (All dimensions in mm.)

# 3x3 mm WDFN 12





## DETAIL A Pin #1 ID and Tie Bar Mark Options

Note : The configuration of the Pin #1 identifier is optional, but must be located within the zone indicated.

Gumbal	Dimensions	n Millimeters	Dimensions In Inches	
Symbol	Min	Max	Min	Max
А	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.175	0.250	0.007	0.010
b	0.150	0.250	0.006	0.010
D	2.950	3.050	0.116	0.120
D2	2.300	2.650	0.091	0.104
E	2.950	3.050	0.116	0.120
E2	E2 1.400	1.750	0.055	0.069
е	0.450		0.0	)18
L	0.350	0.450	0.014	0.018



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## PAM2306D

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